

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|---|------|-----|------|--|--|---------------------|
| 1 | BRS | L8 | 168 | ((multilayer multi adj (layer)) with ceramic with substrate) same electrode and (resin) | USPAT | 2009/02/16 19:10 |
| 2 | BRS | L9 | 229 | ((multilayer multi adj (layer)) with ceramic with substrate) same electrode and (resin) | US-PGPUB; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | 2009/02/16 19:20 |
| 3 | BRS | L12 | 1575 | ((multilayer multi adj layer) with ceramic with substrate) and (device element component) and (resin insulating insulation dielectric) and (contact pad plug bump ball electrode) and (power ground reference adj voltage) | USPAT | 2009/02/16 19:29 |
| 4 | BRS | L13 | 235 | 12 and overlap\$5 | USPAT | 2009/02/16 19:29 |
| 5 | BRS | L14 | 1025 | ((multilayer multi adj layer) with ceramic with substrate) and (device element component) and (resin insulating insulation dielectric) and (contact pad plug bump ball electrode) and (power ground reference adj voltage) | US-PGPUB; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | 2009/02/16 19:38 |
| 6 | BRS | L15 | 182 | 14 and overlap\$5 | US-PGPUB; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | 2009/02/16 19:39 |
| 7 | BRS | L16 | 18 | ((((multilayer multi adj layer) with ceramic with substrate) and (device element component) and (resin insulating insulation dielectric) and (contact pad plug bump ball electrode) and (power ground reference adj voltage))).clm. | US-PGPUB | 2009/02/16 20:47 |
| 8 | BRS | L17 | 1 | ((((multilayer multi adj layer) with ceramic with substrate) and (device element component) and (resin insulating insulation dielectric) and (contact pad plug bump ball electrode) and (power ground reference adj voltage) and overlap\$5)).clm. | US-PGPUB | 2009/02/16 20:48 |